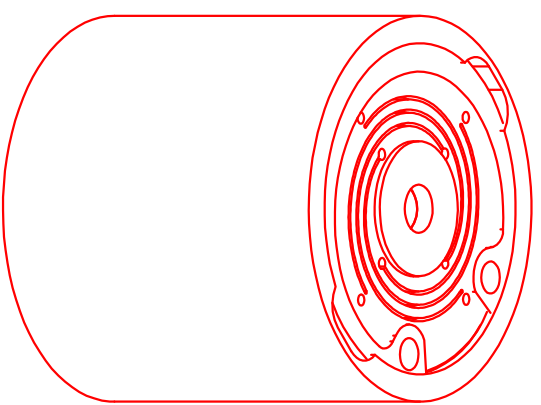
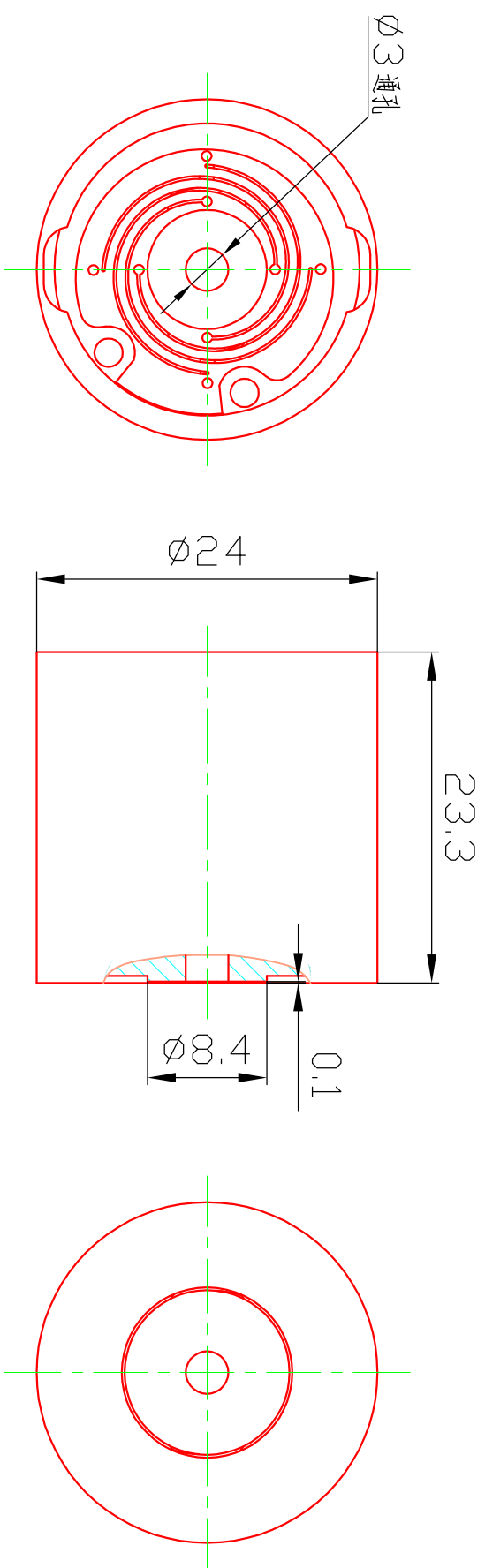
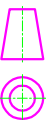




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型 号	H13.Z50K-C1				
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